ISO 9001



# BF451616 Series

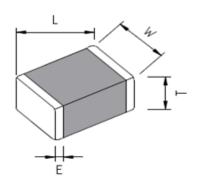
#### Features:

- These small size chips generate high impedance.
- Excellent solderability and high heat resistance for either flow or reflow soldering.
- Monolithic structure for high reliability.
- Low DC resistance structure of electrode prevents wasteful electric power consumption.
- Operating temperature range of -55°C to +125°C
- Storage temperature range of -10°C to +40°C

## Applications:

- Circuit where a stable ground is unavailable.
- Various automotive electronics, various electronic equipment, digital communication equipment.
- Mother board, tablet PC, laptop, desktop computer and peripheral equipment.
- Mobile phone, smart phone, PND.

### Shapes And Dimensions: (Unit:mm)



L	w	Т	E
4.5 ± 0.20	1.6 ± 0.20	1.6 ± 0.20	0.6~1.0

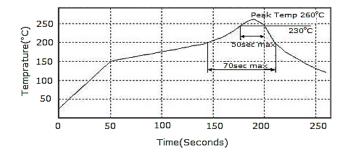
#### Part Number Code:

# BF 451616 A 121 -E ① ② ③ ④ ③

- 1: Series
- 2: Dimensions LxWxT
- 3: Material Code
- 4: Normal Impedance
- 5 : Lead-Free

#### Reflow Profile:

Peak Temp: 260°C Max time above 230°C 50sec Max time above 200°C 70sec



#### BF451616 Series

5. 152020 50.105					
Part No.	Impedance Ω±25% @100MHz	DCR(Ω) (max.)	IDC (mA) (max.)		
BF451616A600	60	0.20	500		
		1			
BF451616A800	80	0.30	400		
BF451616A101	100	0.30	400		
BF451616B151	150	0.50	200		
BF451616B601	600	0.80	200		

